

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

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Title of Invention	MULTIPLE POWER DENSITY CHIP STRUCTURE
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Application Number :

Confirmation Number:

First Named Applicant: Evan Colgan

Attorney Docket Number: FIS920040078US1

Art Unit:

Examiner:

Search string: (6506681 or 5250843 or 6558978 or 6437990 or 6168970 or 4975659 or 4498530 or 5623394 or 5757620 or 5587882 or 20030082847 or 20030015788 or 20030127715 or 20030197252).pn

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
VAMS	1	6506681	2003-01-14	Grigg et al			
	2	5250843	1993-10-05	Eichelberger			
	3	6558978	2003-05-06	McCormick			
	4	6437990	2002-08-20	Degani et al			
	5	6168970	2001-01-02	Burns			
	6	4975659	1990-12-04	Butler et al			
	7	4498530	1985-02-12	Lipschutz			
	8	5623394	1997-04-22	Sherif et al			
	9	5757620	1998-05-26	Edwards et al			
↓	10	5587882	1996-12-24	Patel			

US Published Applications

Note: Applicant is not required to submit a paper copy of cited US Published Applications

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
VAMS	1	20030082847	2003-05-01	Turner et al			
	2	20030015788	2003-01-23	Pogge et al			
	3	20030127715	2003-07-10	Liu et al			
↓	4	20030197252	2003-10-23	Budelman			

Signature

Examiner Name	Date
Doctor A. Mondalas Jr.	1-8-06

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